

Insulated Gate Bi-Polar Transistor

Type T1800GB45A

Absolute Maximum Ratings

	VOLTAGE RATINGS	MAXIMUM LIMITS	UNITS
V_{CES}	Collector – emitter voltage	4500	V
$V_{DC \text{ link}}$	Permanent DC voltage for 100 FIT failure rate.	2800	V
V_{GES}	Peak gate – emitter voltage	± 20	V

	RATINGS	MAXIMUM LIMITS	UNITS
I_C	DC collector current, IGBT	1800	A
I_{CRM}	Repetitive peak collector current, $t_p=1\text{ms}$, IGBT	3600	A
$I_{F(DC)}$	Continuous DC forward current, Diode	1800	A
I_{FRM}	Repetitive peak forward current, $t_p=1\text{ms}$, Diode	3600	A
I_{FSM}	Peak non-repetitive surge $t_p=10\text{ms}$, $V_{RM}=60\%V_{RRM}$, Diode (Note 4)	38.6	kA
I_{FSM2}	Peak non-repetitive surge $t_p=10\text{ms}$, $V_{RM}\leq 10\text{V}$, Diode (Note 4)	42.5	kA
P_{MAX}	Maximum power dissipation, IGBT (Note 2)	13.7	kW
$(di/dt)_{cr}$	Critical diode di/dt (note 3)	3500	A/ μs
T_j	Operating temperature range.	-40 to +125	$^{\circ}\text{C}$
T_{stg}	Storage temperature range.	-40 to +125	$^{\circ}\text{C}$

Notes: -

- 1) Unless otherwise indicated $T_j = 125^{\circ}\text{C}$.
- 2) $T_{sink} = 25^{\circ}\text{C}$, double side cooled.
- 3) Maximum commutation loop inductance 200nH.
- 4) Half-sinewave, 125°C T_j initial.

Characteristics

IGBT Characteristics

	PARAMETER	MIN	TYP	MAX	TEST CONDITIONS	UNITS
$V_{CE(sat)}$	Collector – emitter saturation voltage	-	2.8	3.2	$I_C = 1800A, V_{GE} = 15V, T_j = 25^\circ C$	V
		-	3.6	4.0	$I_C = 1800A, V_{GE} = 15V$	V
V_{T0}	Threshold voltage	-	-	1.82	Current range: 600A – 1800A	V
r_T	Slope resistance	-	-	1.21		mΩ
$V_{GE(TH)}$	Gate threshold voltage	-	5.1	-	$V_{CE} = V_{GE}, I_C = 180mA$	V
I_{CES}	Collector – emitter cut-off current	-	45	70	$V_{CE} = V_{CES}, V_{GE} = 0V$	mA
I_{GES}	Gate leakage current	-	-	±20	$V_{GE} = \pm 20V$	μA
C_{ies}	Input capacitance	-	280	-	$V_{CE} = 25V, V_{GE} = 0V, f = 1MHz$	nF
$t_{d(on)}$	Turn-on delay time	-	1.5	-	$I_C = 1800A, V_{CE} = 2800V, di/dt = 3000A/\mu s$	μs
$t_r(V)$	Rise time	-	3.3	-		μs
$Q_{g(on)}$	Turn-on gate charge	-	12.5	-	$V_{GE} = \pm 15V, L_s = 200nH$	μC
E_{on}	Turn-on energy	-	11	-	$R_{g(ON)} = 3\Omega, R_{g(OFF)} = 11\Omega, C_{GE} = 183nF$	J
$t_{d(off)}$	Turn-off delay time	-	4.7	-	Integral diode used as freewheel diode (Note 3 & 4)	μs
$t_f(I)$	Fall time	-	2.5	-		μs
$Q_{g(off)}$	Turn-off gate charge	-	10	-		μC
E_{off}	Turn-off energy	-	10.5	-		J
I_{SC}	Short circuit current	-	5500	-	$V_{GE} = +15V, V_{CC} = 2800V, V_{CEmax} \leq V_{CES}, t_p \leq 10\mu s$	A

Diode Characteristics

	PARAMETER	MIN	TYP	MAX	TEST CONDITIONS	UNITS
V_F	Forward voltage	-	3.7	4.0	$I_F = 1800A, T_j = 25^\circ C$	V
		-	3.9	4.2	$I_F = 1800A$	V
V_{T0}	Threshold voltage	-	-	2.27	Current range 600A - 1800A	V
r_T	Slope resistance	-	-	1.07		mΩ
I_{rm}	Peak reverse recovery current	-	1600	-	$I_F = 1800A, V_r = 2800V, V_{GE} = -15V, di/dt = 3000A/\mu s$	A
Q_{rr}	Recovered charge	-	2000	-		μC
t_{rr}	Reverse recovery time, 50% chord	-	1.6	-		μs
E_r	Reverse recovery energy	-	2.8	-		J

Thermal Characteristics

	PARAMETER	MIN	TYP	MAX	TEST CONDITIONS	UNITS
R_{thJK}	Thermal resistance junction to sink, IGBT	-	-	7.3	Double side cooled	K/kW
		-	-	11.9	Collector side cooled	K/kW
		-	-	19	Emitter side cooled	K/kW
R_{thJK}	Thermal resistance junction to sink, Diode	-	-	14.4	Double side cooled	K/kW
		-	-	22.3	Cathode side cooled	K/kW
		-	-	41.1	Anode side cooled	K/kW
F	Mounting force	50	-	70	Note 2	kN
W_t	Weight	-	2	-		kg

Notes:-

- 1) Unless otherwise indicated $T_j = 125^\circ C$.
- 2) Consult application note 2008AN01 for detailed mounting requirements
- 3) C_{GE} is additional gate – emitter capacitance added to output of gate drive
- 4) Figures 6 to 9 are obtained using integral diode as freewheeling diode

Curves

Figure 1 – Typical collector-emitter saturation voltage characteristics

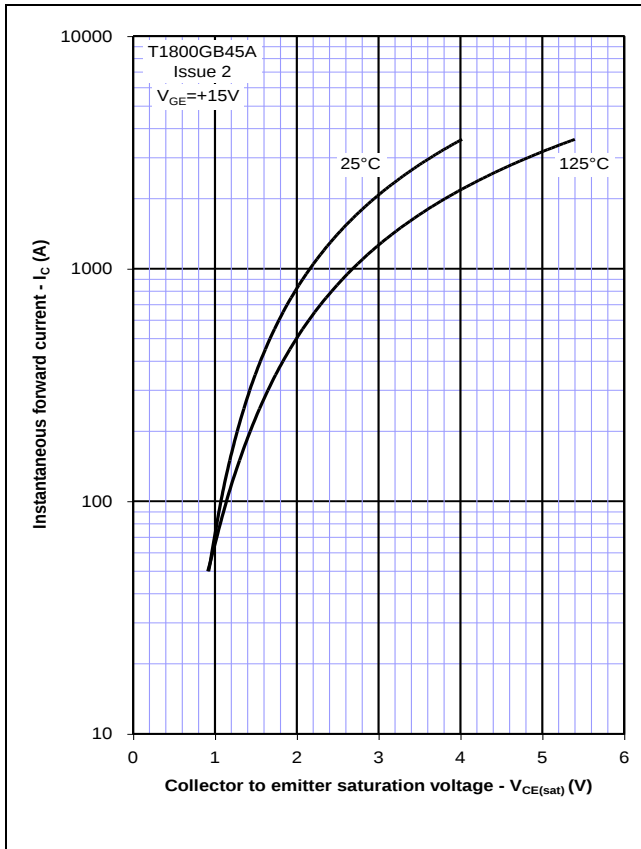


Figure 2 – Typical output characteristic

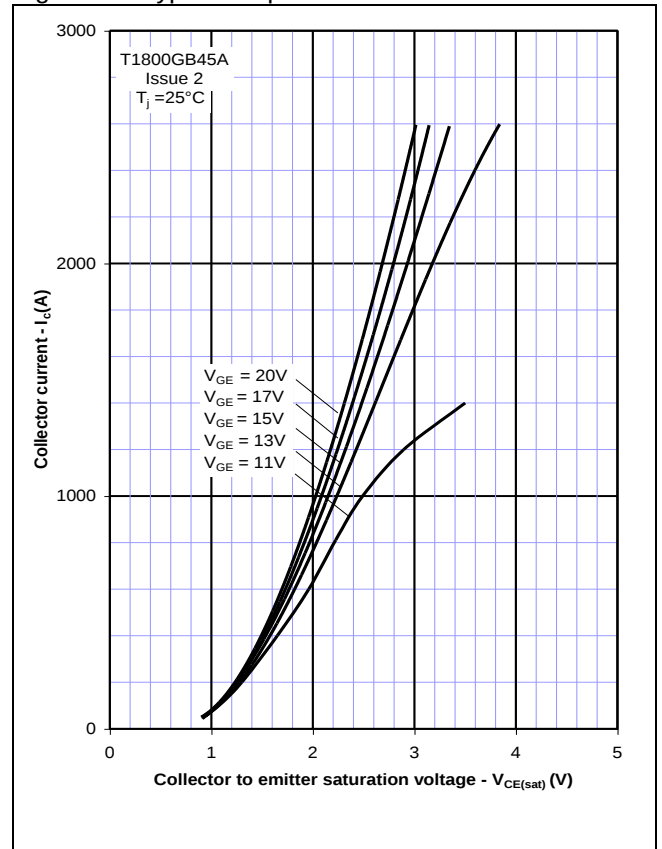


Figure 3 – Typical output characteristic

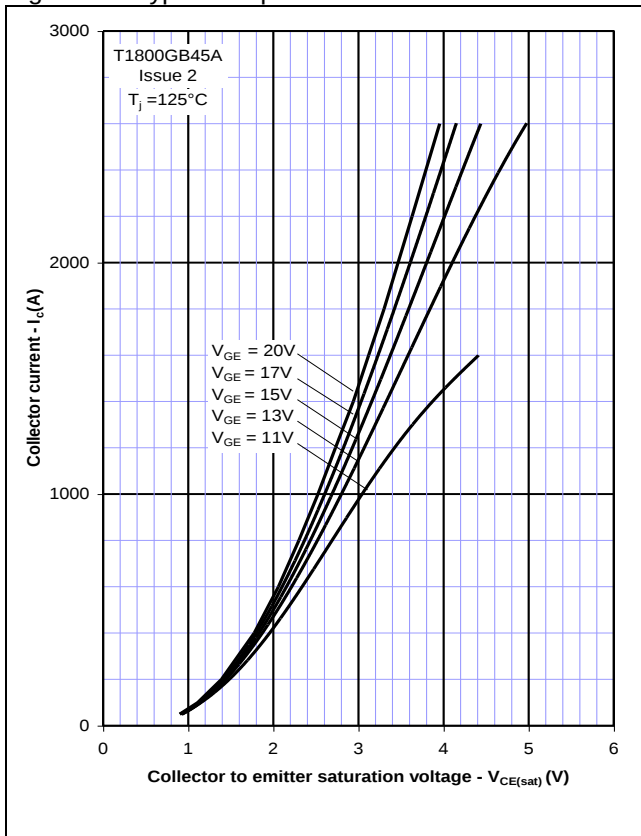


Figure 4 – Typical turn-on delay time vs gate resistance

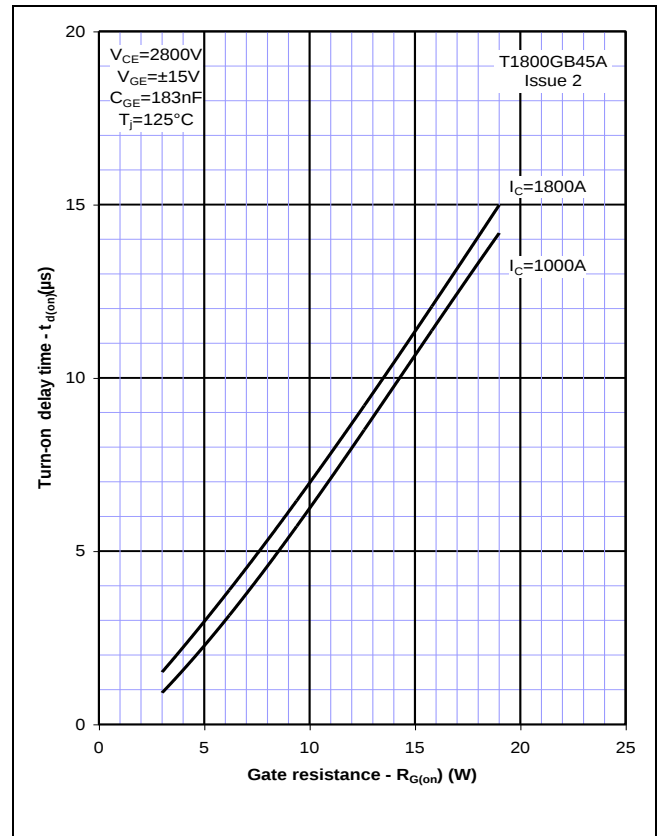


Figure 5 – Typical turn-off delay time vs. gate resistance

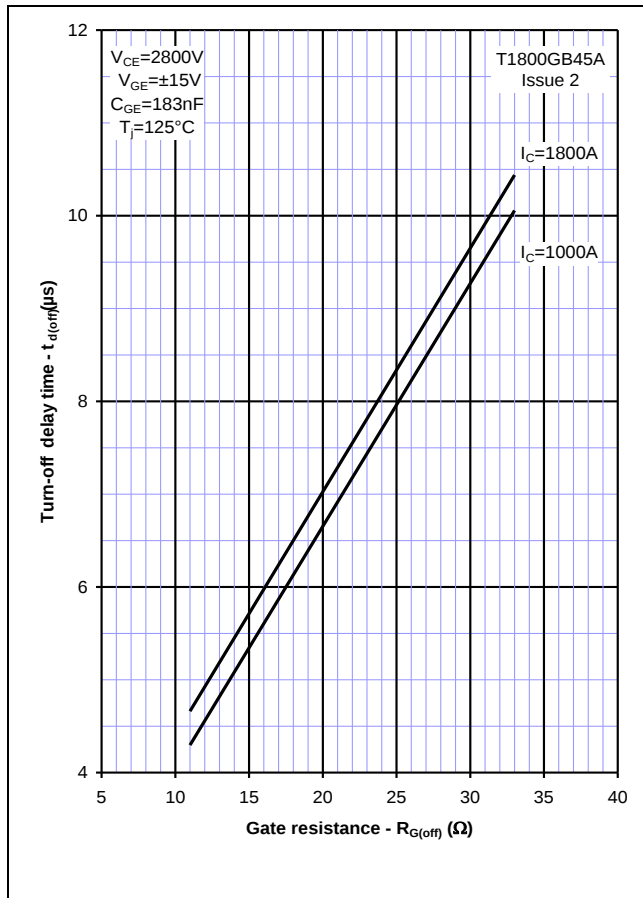


Figure 6 – Typical turn-on energy vs. collector current

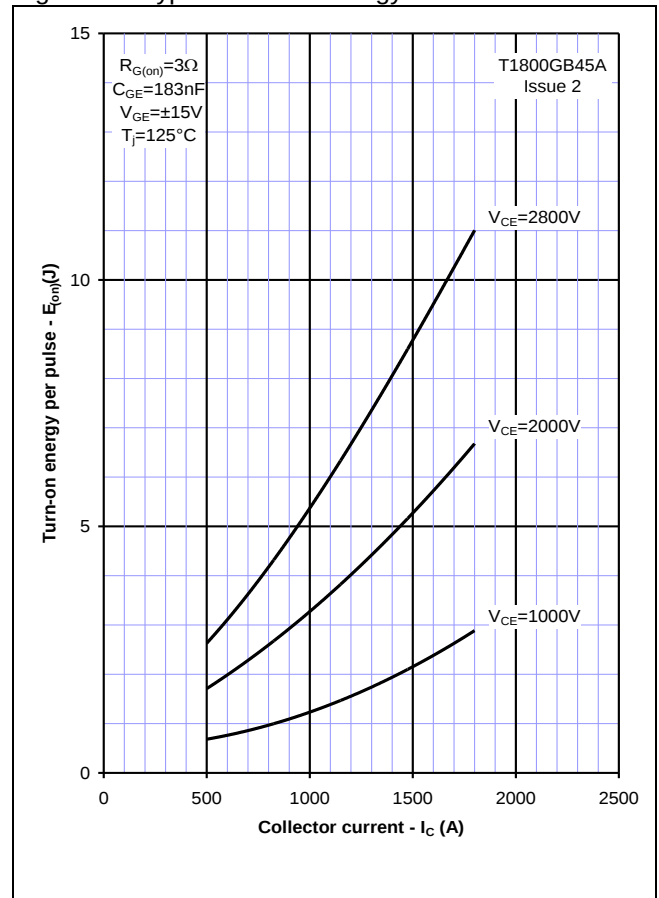


Figure 7 – Typical turn-on energy vs. di/dt

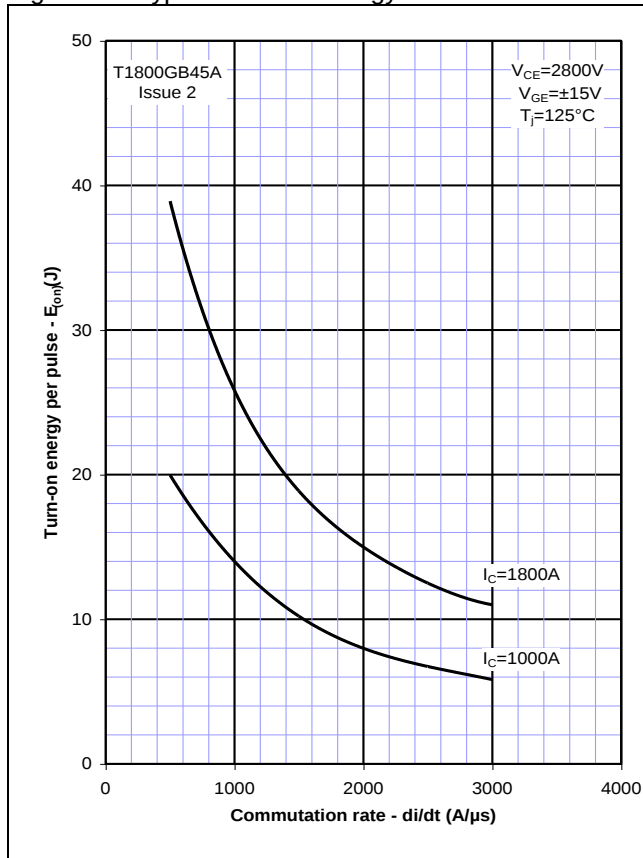


Figure 8 – Typical turn-off energy vs. collector current

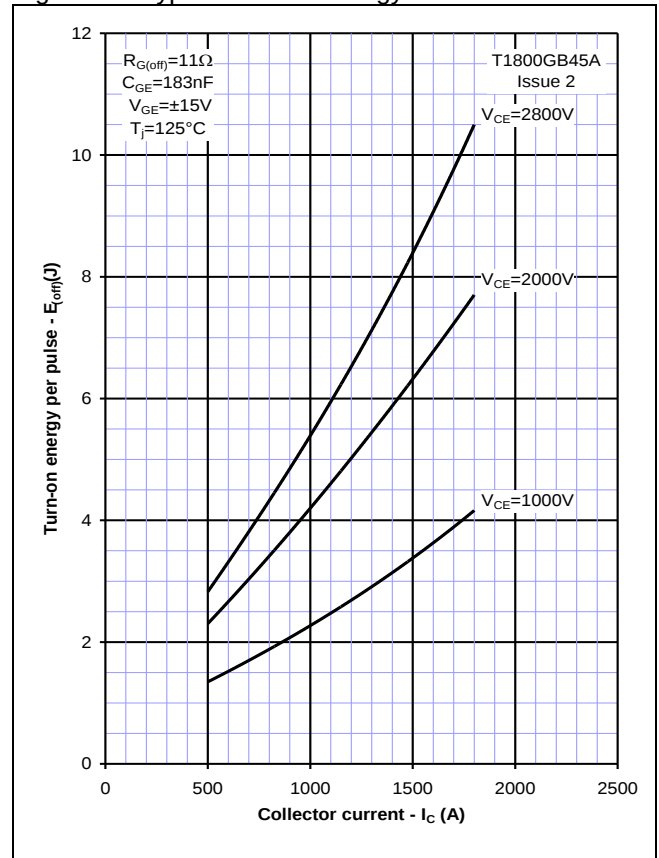


Figure 9 – Turn-off energy vs voltage

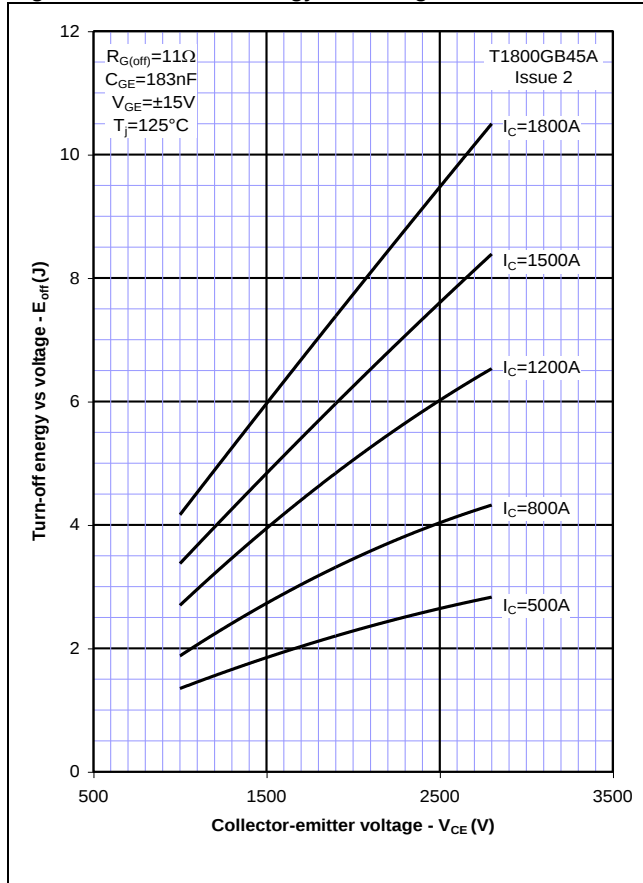


Figure 10 – Safe operating area (IGBT)

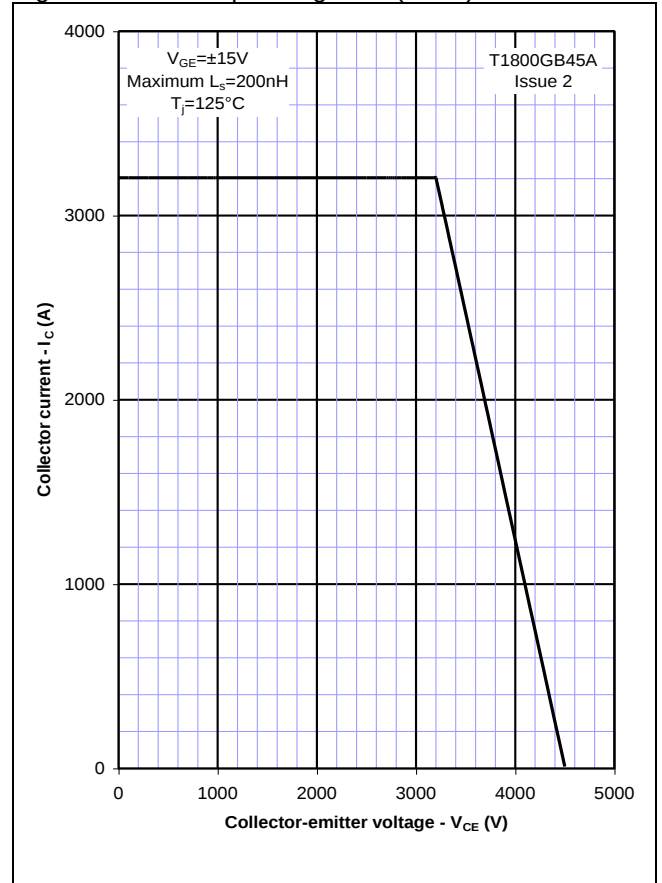


Figure 11 – Typical diode forward characteristics

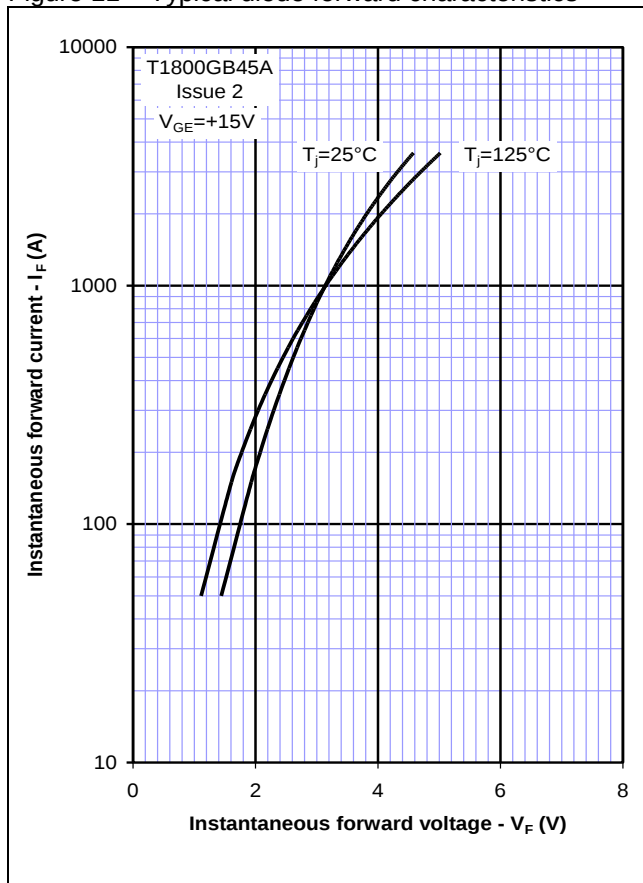


Figure 12 – Typical recovered charge

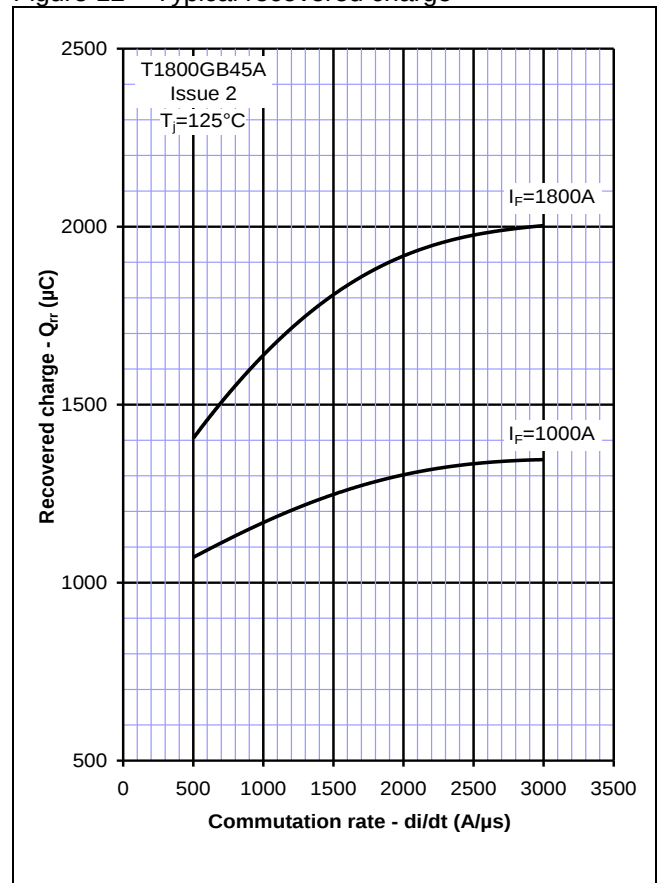


Figure 13 – Typical reverse recovery current

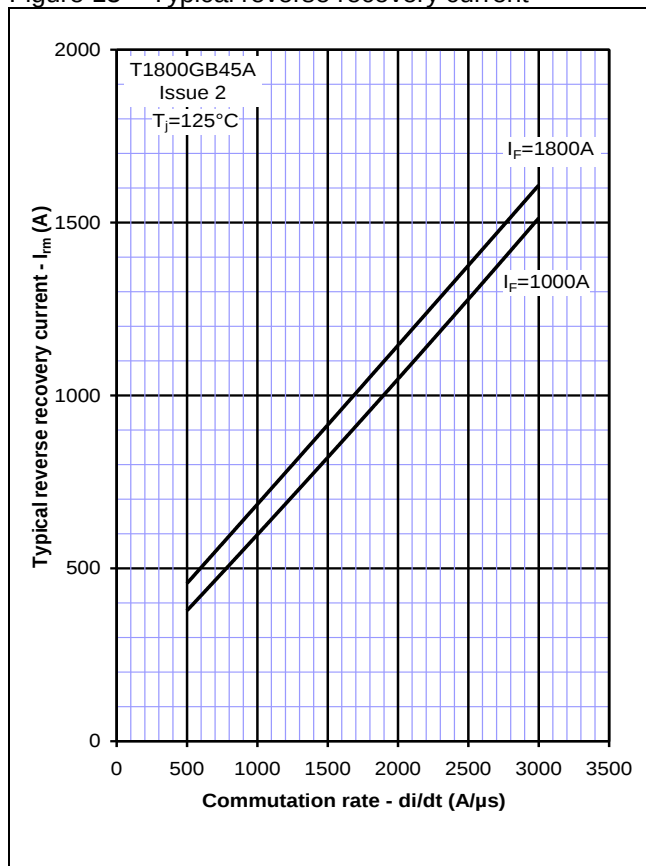


Figure 14 – Typical reverse recovery time

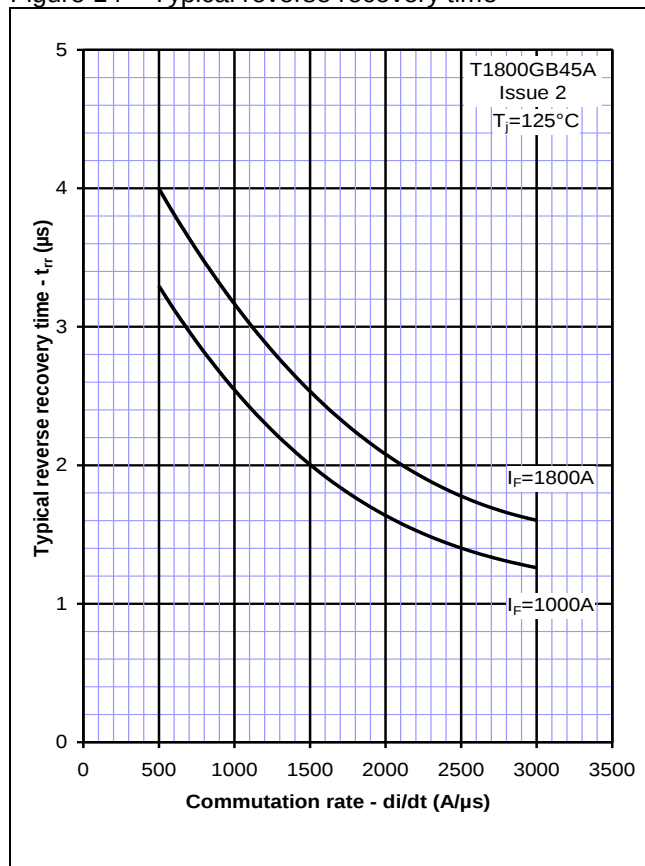


Figure 15 – Typical reverse recovery energy

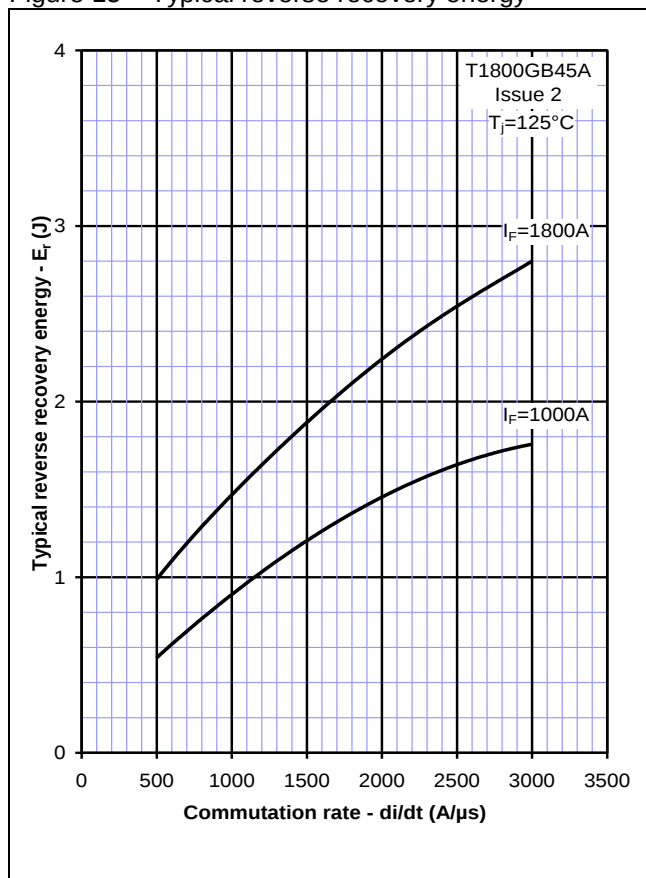


Figure 16 – Safe operating area (Diode)

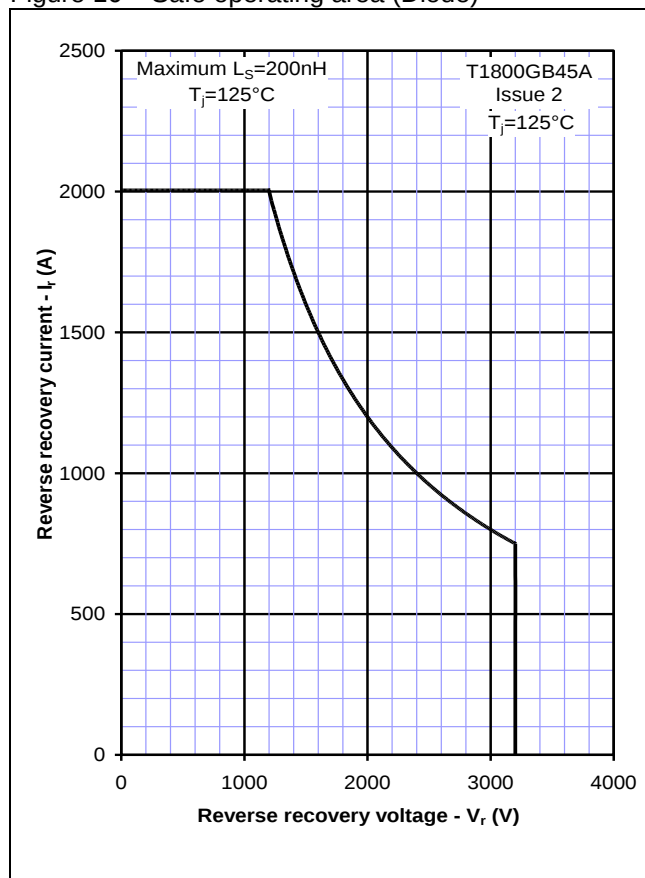


Figure 17 – Transient thermal impedance (IGBT)

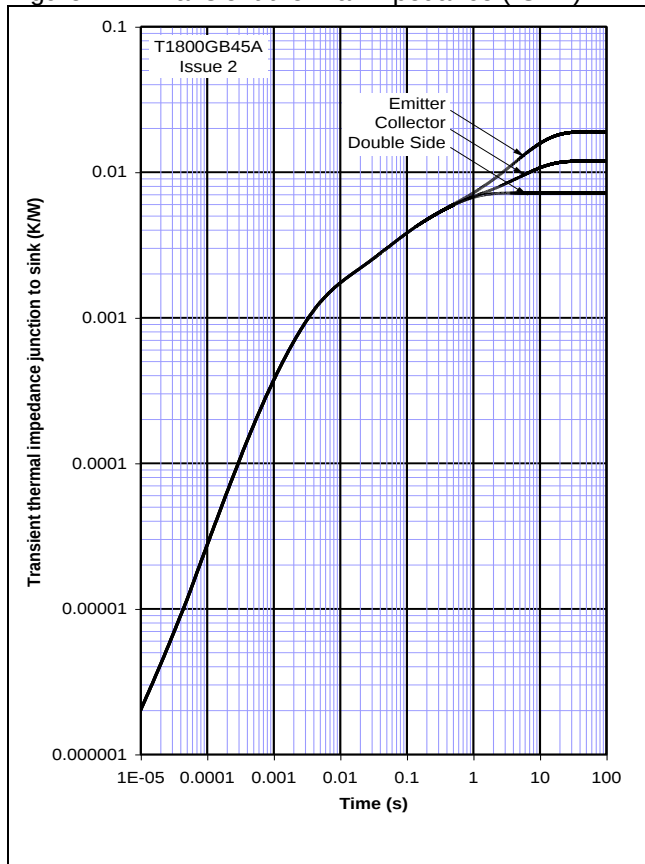
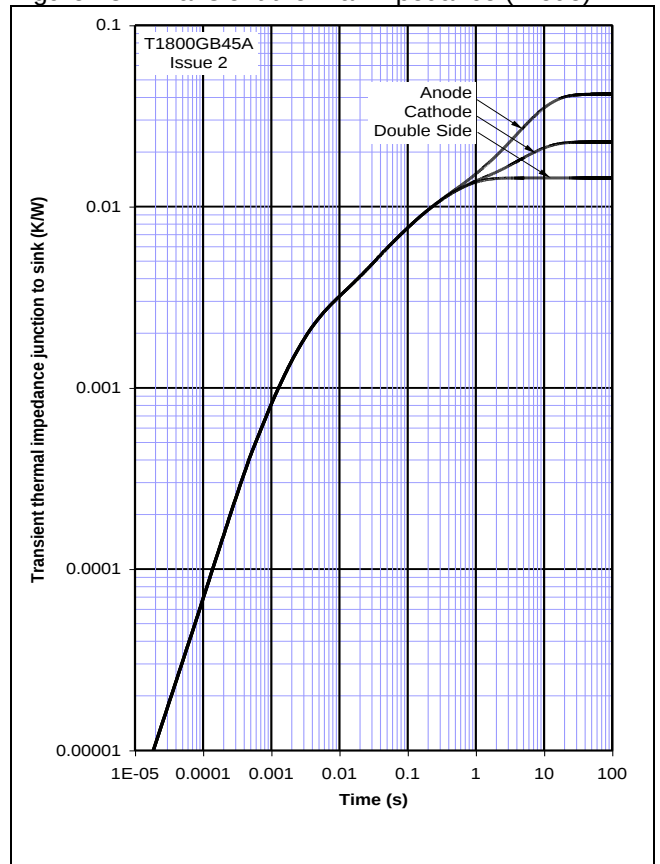
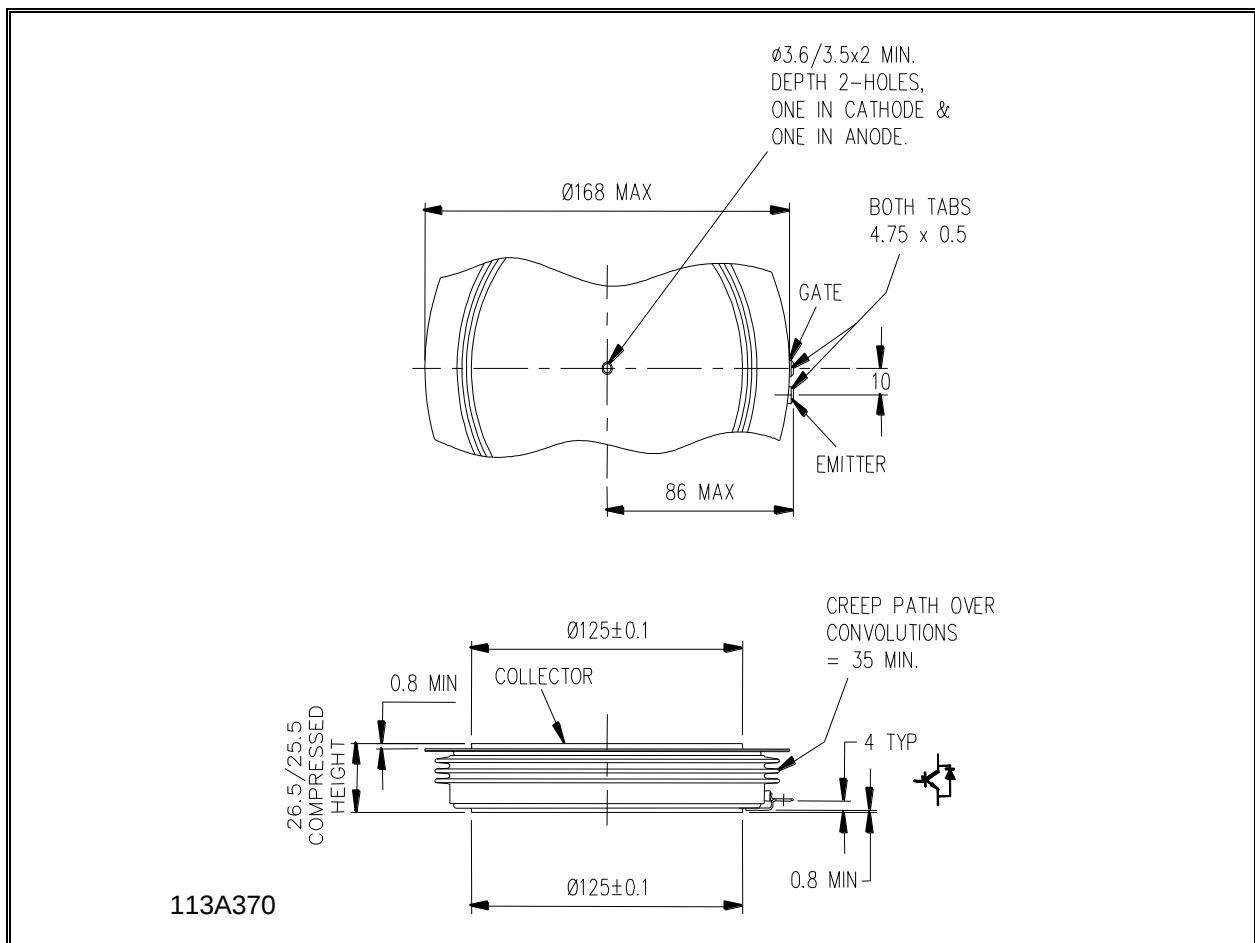


Figure 18 – Transient thermal impedance (Diode)



Outline Drawing & Ordering Information



ORDERING INFORMATION

(Please quote 10 digit code as below)

T1800	GB	45	A
Fixed type Code	Fixed Outline Code	Voltage Grade $V_{CES}/100$ 45	Fixed format code

Typical order code: T1800GB45A ($V_{CES} = 4500V$)

IXYS Semiconductor GmbH
Edisonstraße 15
D-68623 Lampertheim
Tel: +49 6206 503-0
Fax: +49 6206 503-627
E-mail: marcom@ixys.de



IXYS UK Westcode Ltd
Langley Park Way, Langley Park,
Chippenham, Wiltshire, SN15 1GE.
Tel: +44 (0)1249 444524
Fax: +44 (0)1249 659448
E-mail: sales@ixysuk.com

IXYS Corporation
1590 Buckeye Drive
Milpitas CA 95035-7418
Tel: +1 (408) 457 9000
Fax: +1 (408) 496 0670
E-mail: sales@ixys.net

www.ixysuk.com

www.ixys.net

IXYS Long Beach
IXYS Long Beach, Inc
2500 Mira Mar Ave, Long Beach
CA 90815
Tel: +1 (562) 296 6584
Fax: +1 (562) 296 6585
E-mail: service@ixyslongbeach.com

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